

**5K or not?
&
TTF module thermal modeling update**

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Loads on the 5 K shield

Temperature Level			2K
RF load			7,46
Supports	0,60	-	
Input coupler	0,55	0,16	
HOM coupler (cables)	0,01	0,18	
HOM absorber	0,14	0,01	
Beam tube bellows		0,36	
Current leads	0,28	0,28	
HOM to structure		1,20	
Coax cable (4)	0,05		
Instrumentation taps	0,07		
Scales as Gfac			7,83
Scales as Pfac			0,16
Independent of G,Tf			1,70
Static, dynamic sum			1,70
2K Sum [W]			11,4

5K		
Radiation	1,41	
Supports	2,40	
Input coupler	1,48	1,32
HOM coupler (cables)	0,29	1,82
HOM absorber	3,13	0,76
Current leads	0,47	0,47
Diagnostic cable	1,39	-
Scales as Pfac		1,32
Independent of G,Tf		10,56
Static, dynamic sum		10,56
5K Sum [W]		14,9

lead to increase on static
not the same MLI!



provide thermal intercepts on the many penetrations!

- couplers x 8 (9)
- leads
- cables

Shield surface provides surface for thermal strapping with small braids

From Webex SCRF meeting on 5 K shield removal

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5 K shield removal: what happens @ 2K?

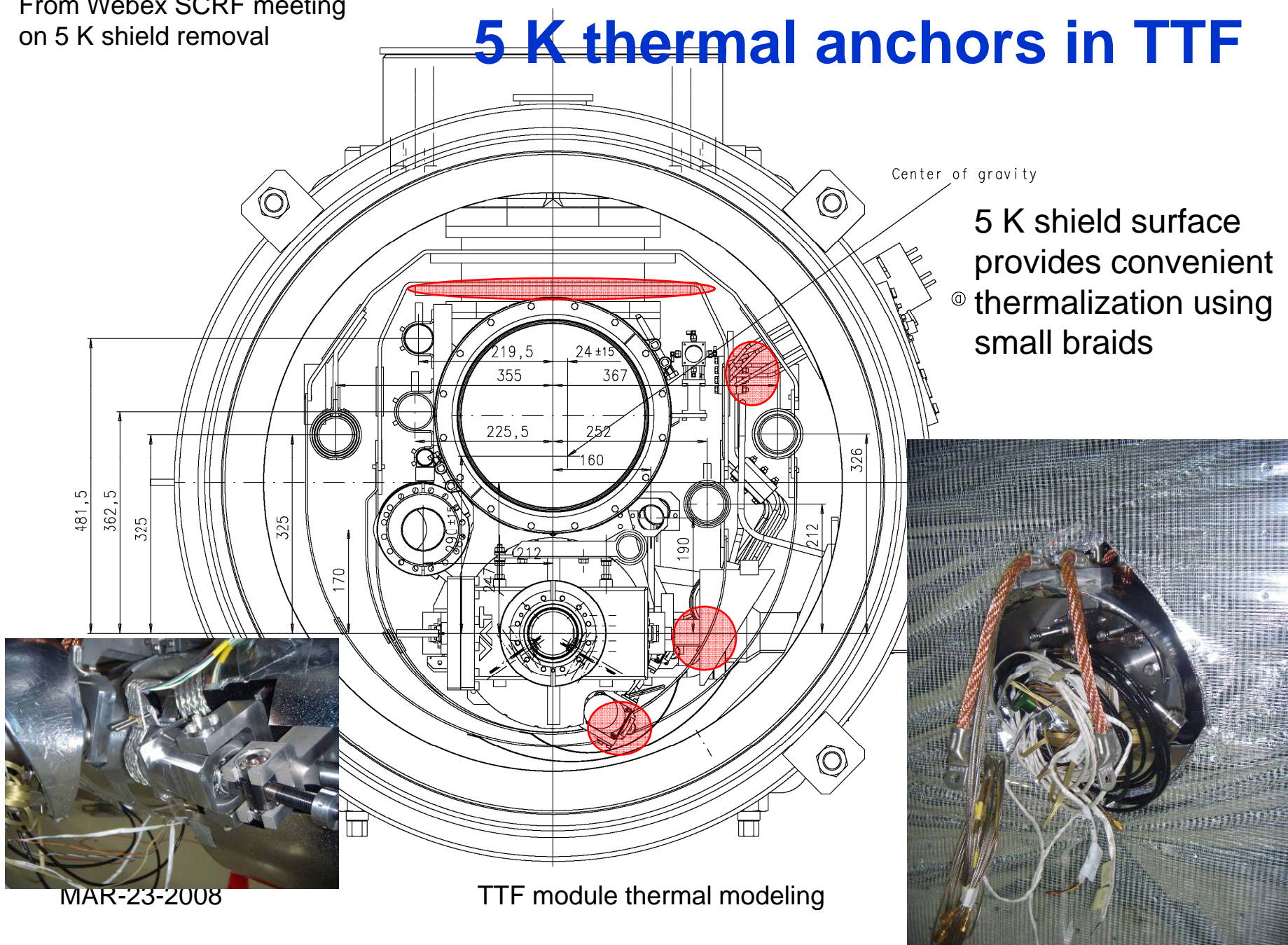
- From Tom Cryo spreadsheet (Feb07)
 - 2K: 11.4 (1.7 s + 9.7 d) @ 700 W/W
 - 5K: 15.0 (10.6 s + 4.4 d) @ 200 W/W
 - 40K: 153.5 (59.2 s + 94.3 d) @ 16 W/W
 - Sum **14.4 kW** plug power for each module (no overcapacity)
- If all 5K load goes into 2K “as is”
 - Plug power increased by 56%
 - Need to provide same efficient radiation shield for the 2K mass, with at least 10 layers MLI protecting the 2K cold mass
- If only radiation flow into 2K (consider factor 2 increase for worse MLI protection) and **all conduction** intercepted
 - Plug power increased by 15%
 - 5K thermalization for 3 posts, 8-9 couplers, HOM, leads, cables

Operation vs Capital

- Range of effect on plug power (operation cost) is 15% to 55% **without redesigning cross section**
 - optimistic conditions given the many penetrations that the module has to the 2 K environment, and **located at different positions along the transverse section (support at top, couplers to the side)**
 - Bulky braids?
 - We need anyway a 5K cryo circuit for 90% of the conduction heat removal

From Webex SCRF meeting
on 5 K shield removal

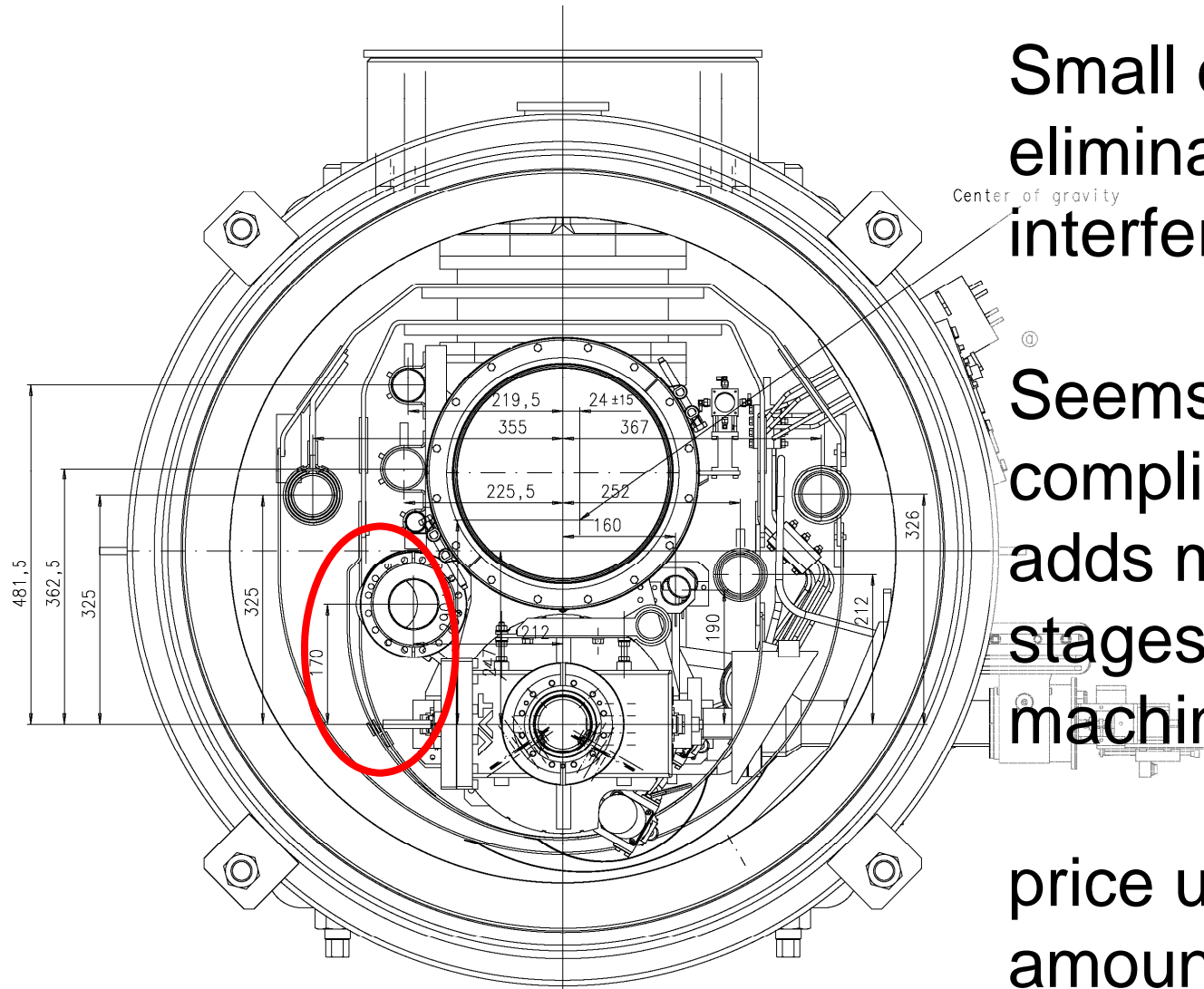
5 K thermal anchors in TTF



Type I--III

- “Historical” note: One of the most effective cost reduction strategies from generation I to generation II was the elimination of the many braids to perform the shield thermalization
- Sometimes changes that seem minor have heavy implications later in terms of complexity or cost
 - e.g. discussions yesterday/today of modules plug compatibility between regions
 - changes in the shield geometry from Typell+ to XFEL proto

Example: Type III+ modification



Small change to eliminate interferences

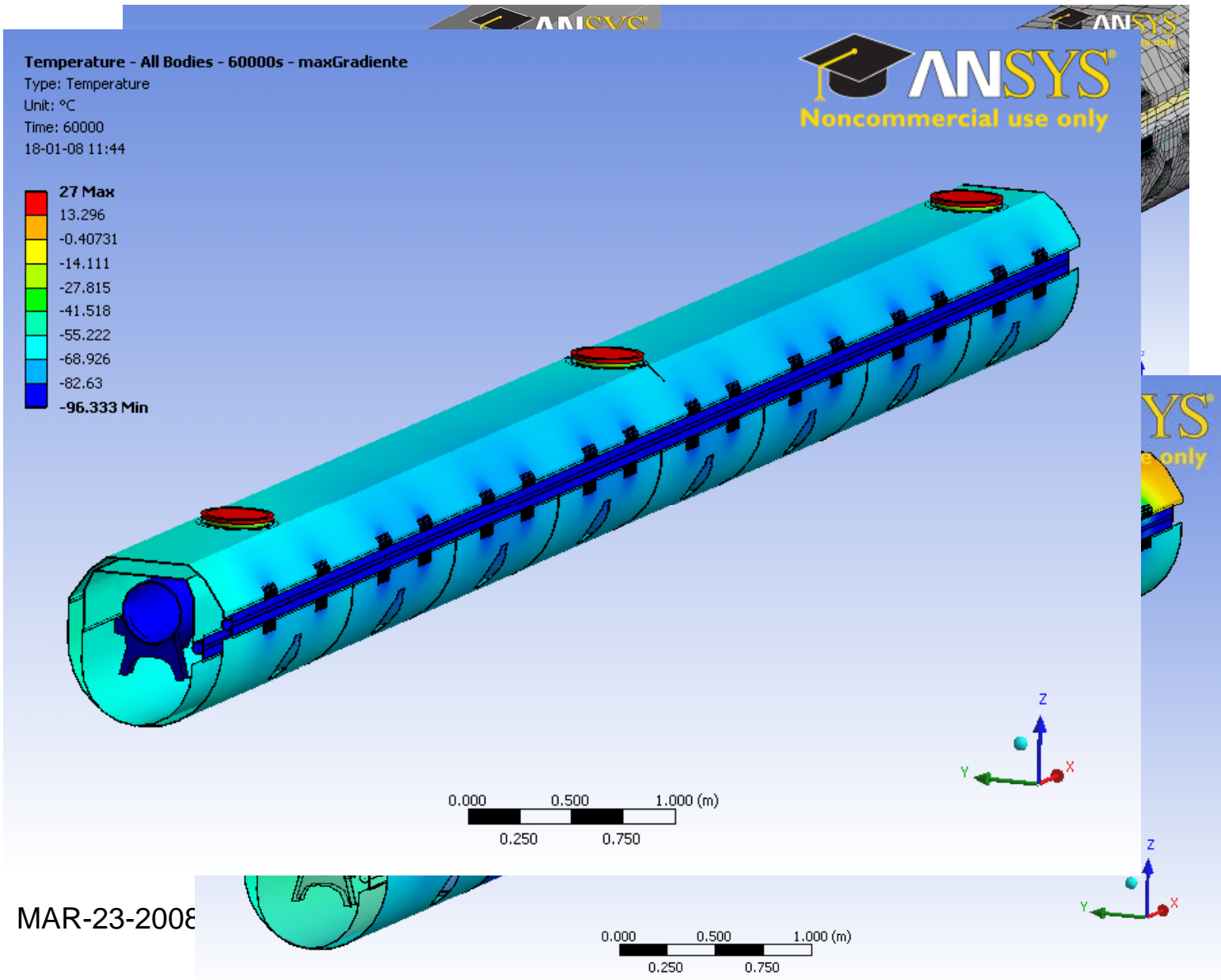
Seems minor, but it complicates life and adds manufacturing stages (in/out rolling machine)

price up, estimate amounts to 5-7%

TTF Thermal analysis with ANSYS

- We did transient thermal analysis 12 years ago on shields only
- Serena developed an ANSYS model for static and transient thermal behavior aimed at
 - static and transient heat loads,
 - thermal gradients on the internals during transient, ...
 - comparison of different cooling procedures
- Opportunity to benchmark with **present M3* testing at CMTB**
 - The input data (cool down times, flow rates, ...)
 - from CMTB cryogenic system
 - Several cooldowns available
 - A new set of thermal sensor has been included in CMTB

Model overview



Thermal conditions

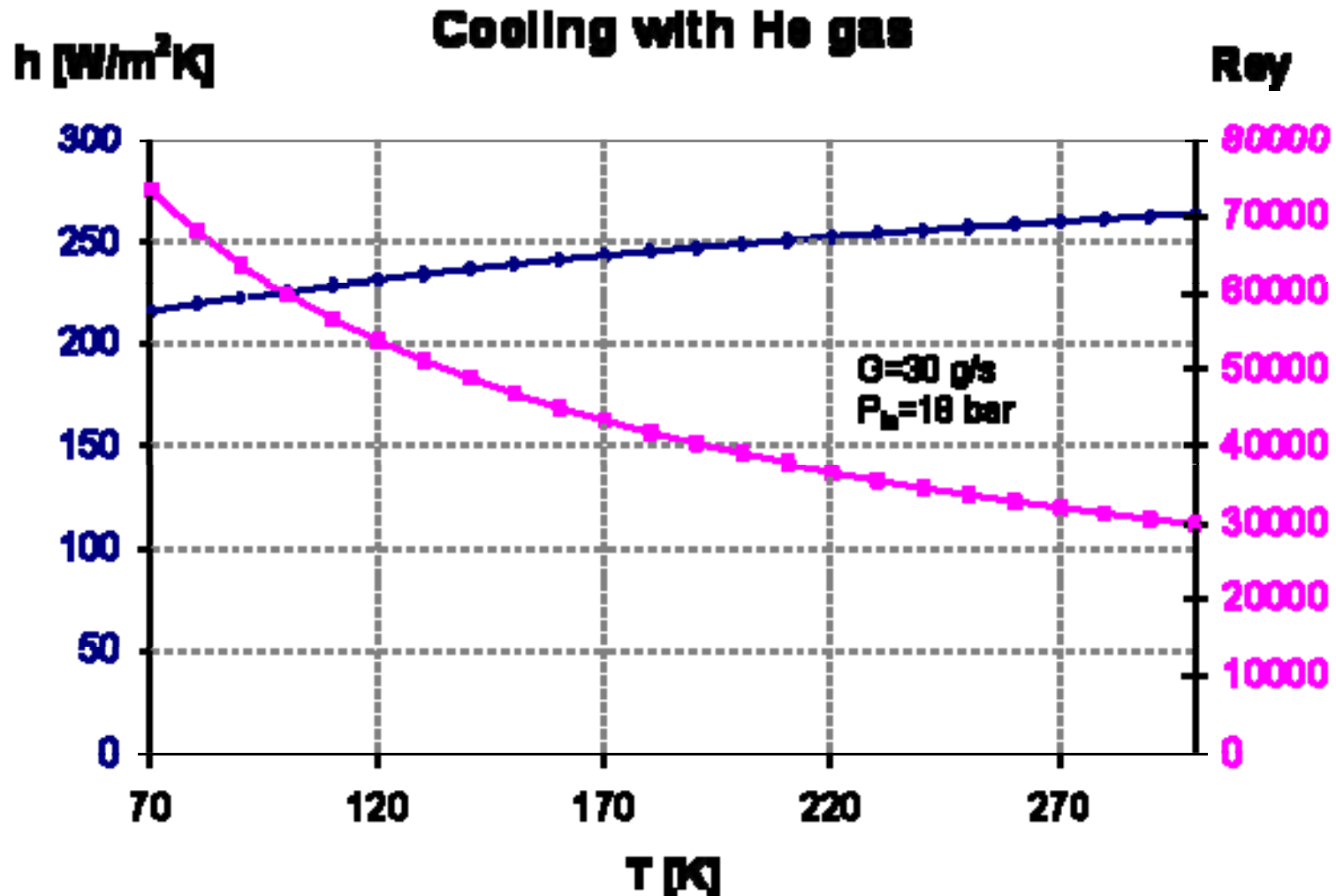
- In the simulation (both static and transient) we have implemented the following thermal conditions:
 - Cooling provided by **convection** at the finned Aluminum tubes integrated in both the 5 K and 70 K shields
 - **Conduction** through penetration and supports (posts, couplers)
 - Thermal **radiation** load
 - 300 K thermal boundary at top of posts
- Under development: still working on or planning
 - Model so far has double shield and no radiation load at 2 K
 - No single shield model
 - Details of cavity tanks are still missing
 - Imposed temperature at the GRP and connections to tanks

Heat conditions in the transient analysis

- Time dependent convection cooling at the 5 K and 70 K finned tubes and HeGRP
 - Linear T decrease
 - Evaluation of h_f from fluid
 - Imposed linear temperature decrease at the 2 K cavity boundary, with no limit to heat exchange
- Time dependent heat loads:
 - Radiation heat flux acting on the shields surfaces
 - Conduction effects from couplers being implemented at 70 K, 5 K and 2K
 - not modeling real coupler geometry, though
 - heat load at the thermal anchors positions on the shields

Convective heat exchange on 70 K pipe

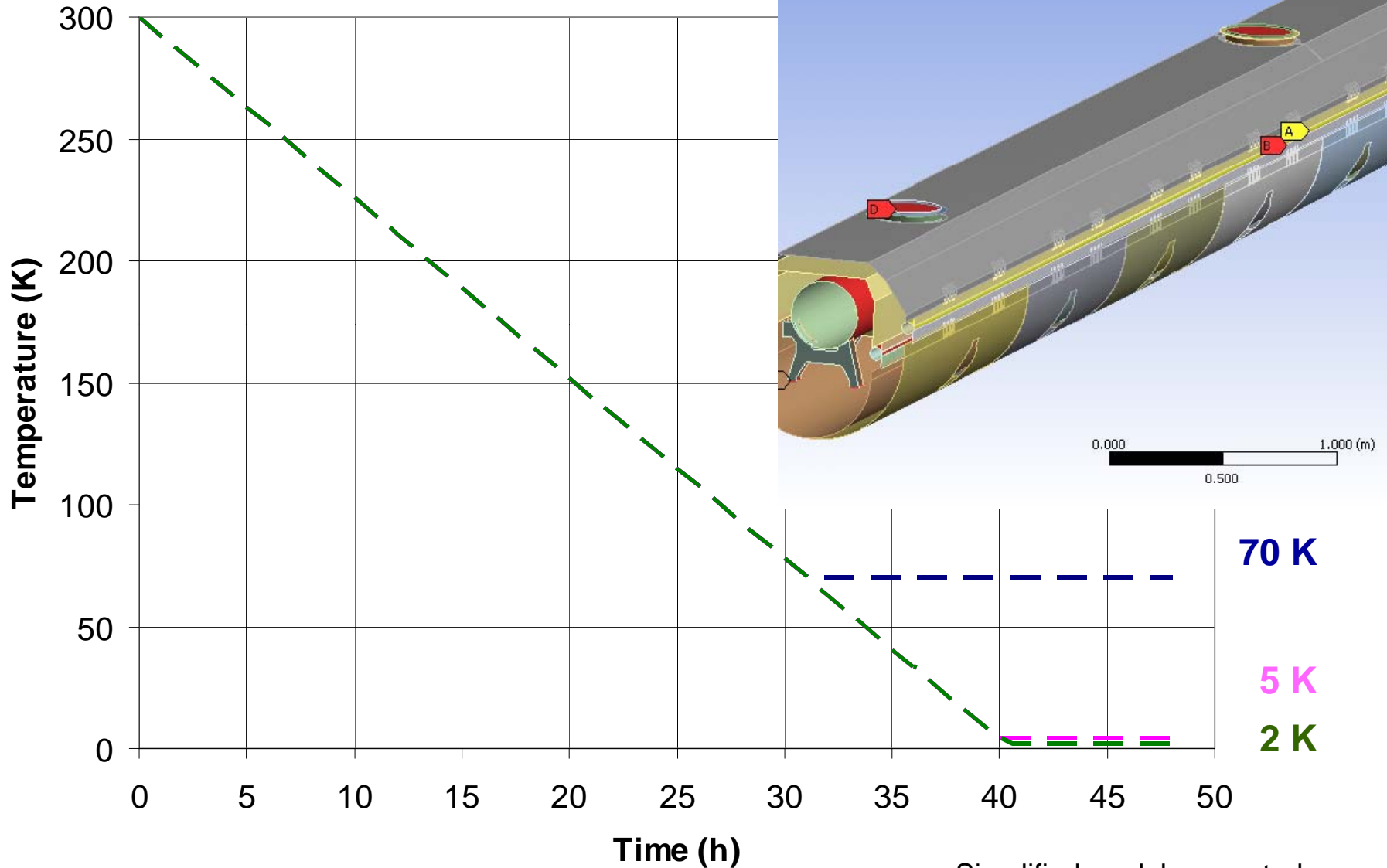
Derived from fluid properties (T, P, ...) and mass flows



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Cooldown rates (linear)



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Simplified model presented at Sendai, simple linear loads

Radiation load through MLI

- CERN data used so far
 - From r.t. to negligible temperatures using 30 layers MLI
 - 1 W/m²
 - From 80 K to negligible temperatures using 10 layers MLI
 - 0.05 W/m²
- Scale behavior during cooldown from these data using experimental plots reported in J. Weisend text

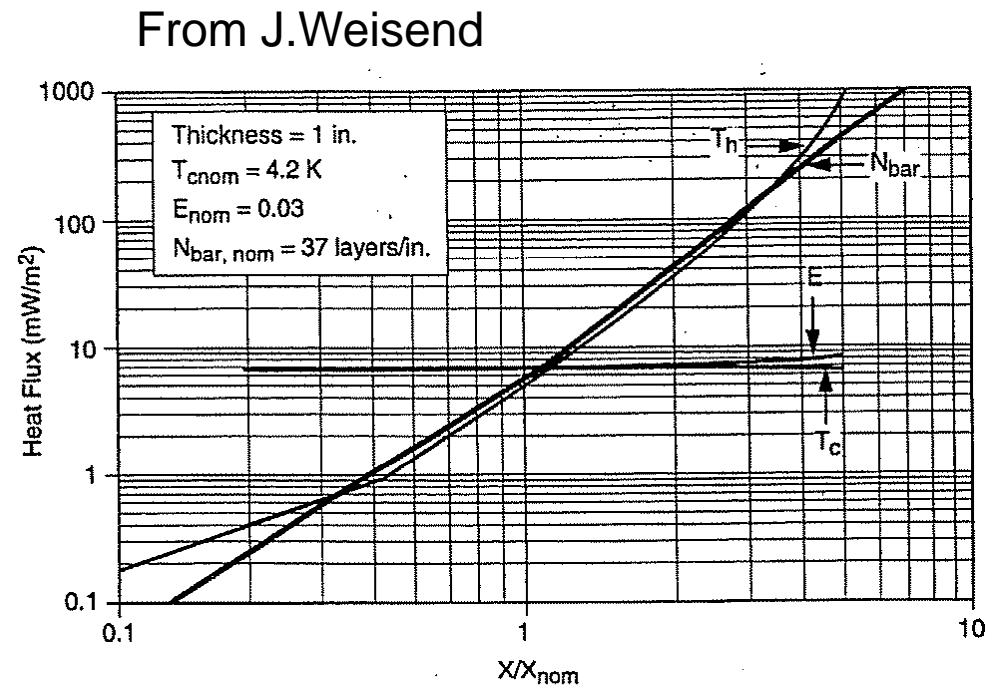
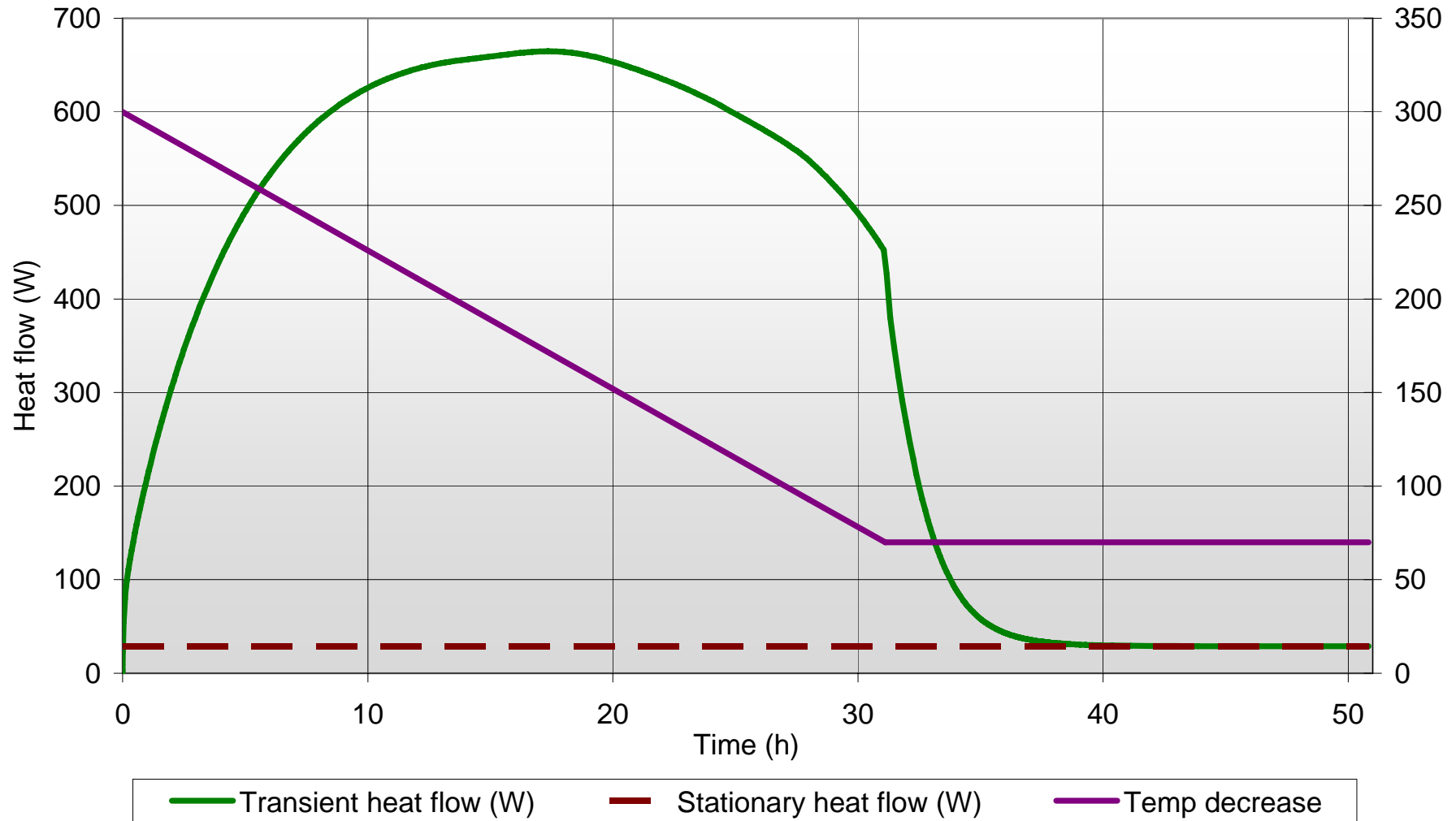


Figure 3-31 X/X_{nom} effects for nominal warm boundary temperature of 77 K.

Heat flow on 70 K pipe during cooldown

Heat flow at the 70 K tube surface



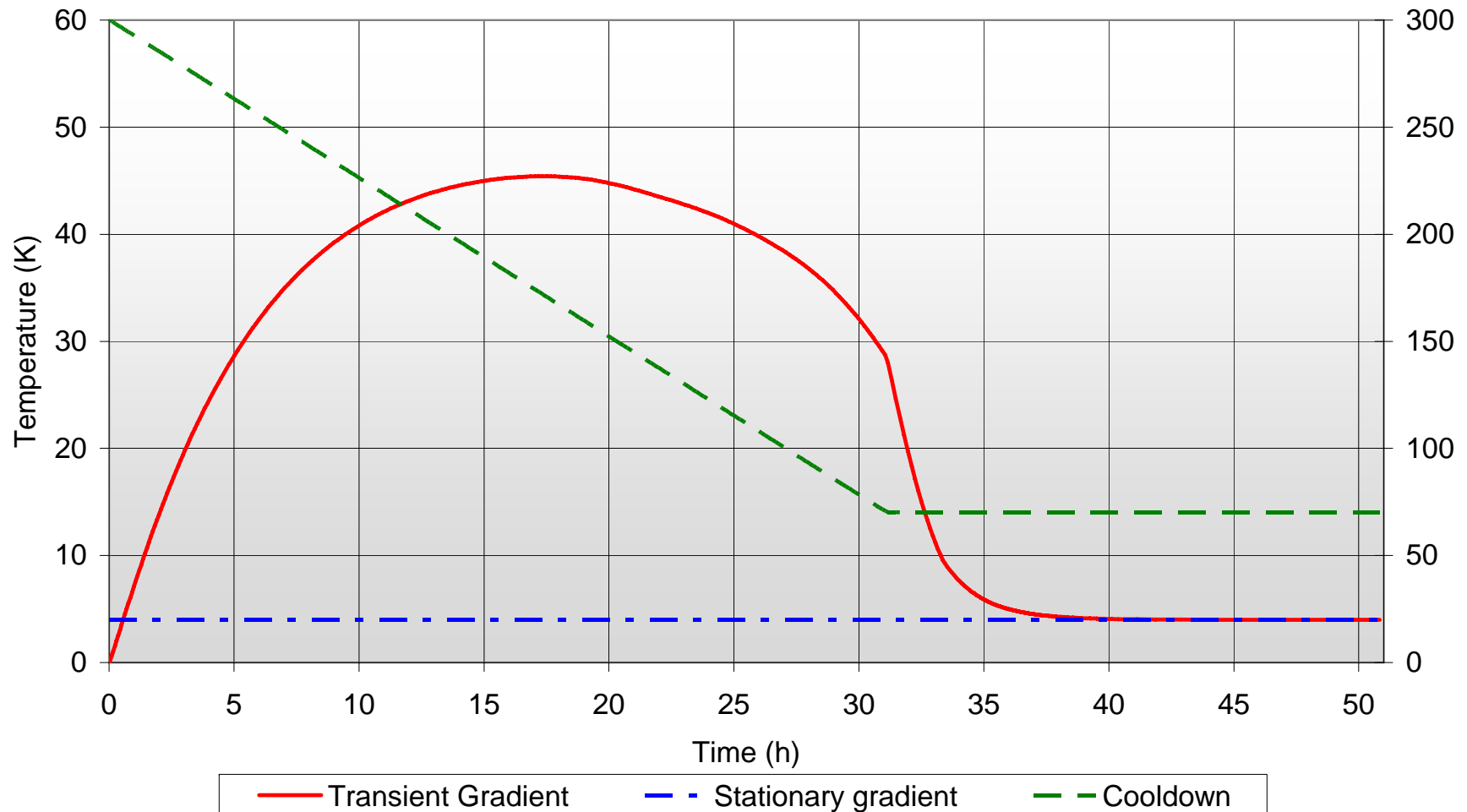
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Gradient on 70 K shield

Max gradient on shield: cool down in 40 hours



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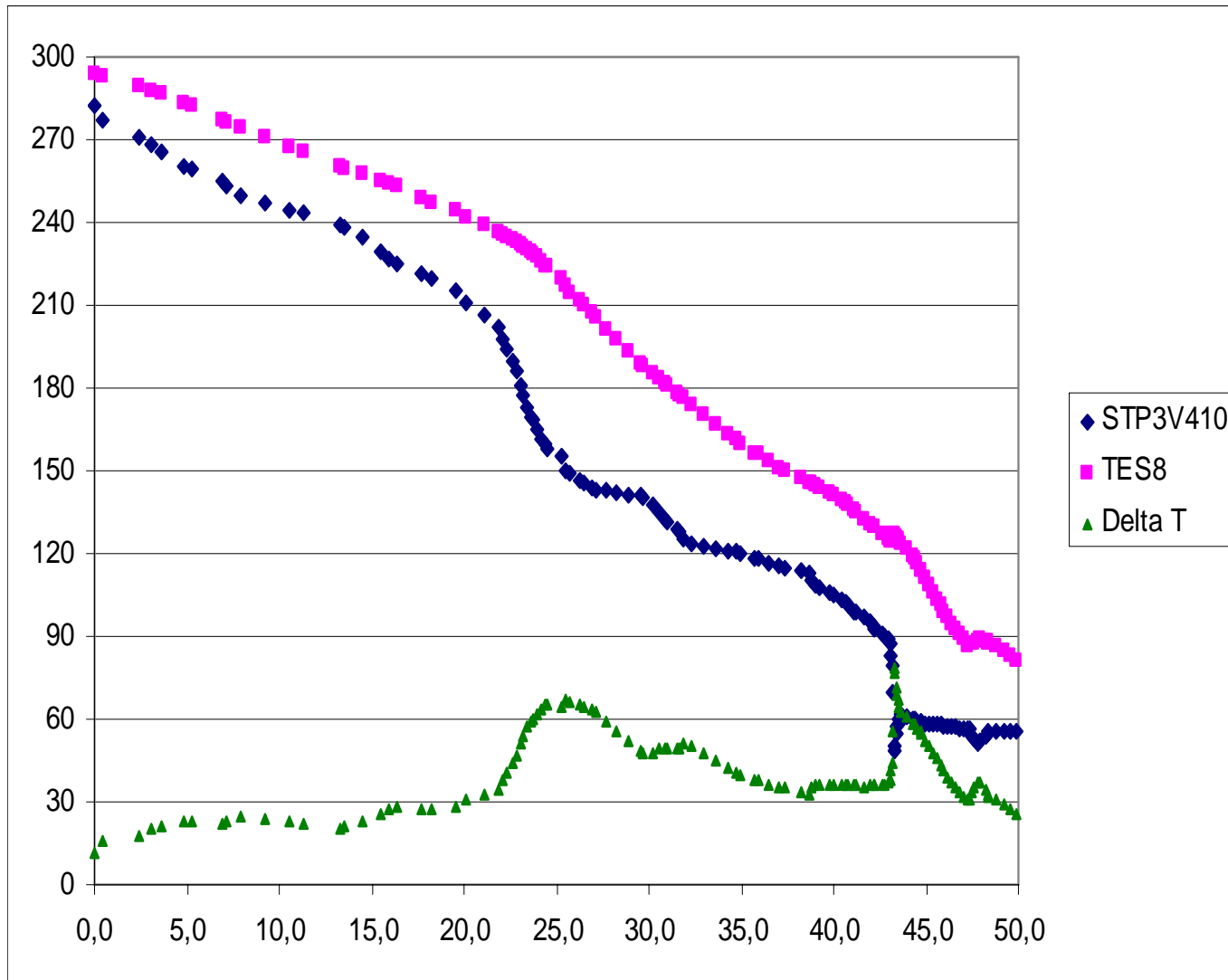
TTF module thermal modeling

Simplified model presented at Sendai, simple linear loads

Work still in progress...

- Further implementation of heat load sources and complexity of loading conditions
- Using CMTB cooldown data
- Getting CMTB data from DESY to be analyzed
 - provides model benchmark
- TO DO: Structural analysis at maximum gradients
 - mechanical interferences
- Model can be extended for exploring different cooldown procedures or thermal intercept strategies
- Big help from W. Maschmann, K. Jensch, R. Lange

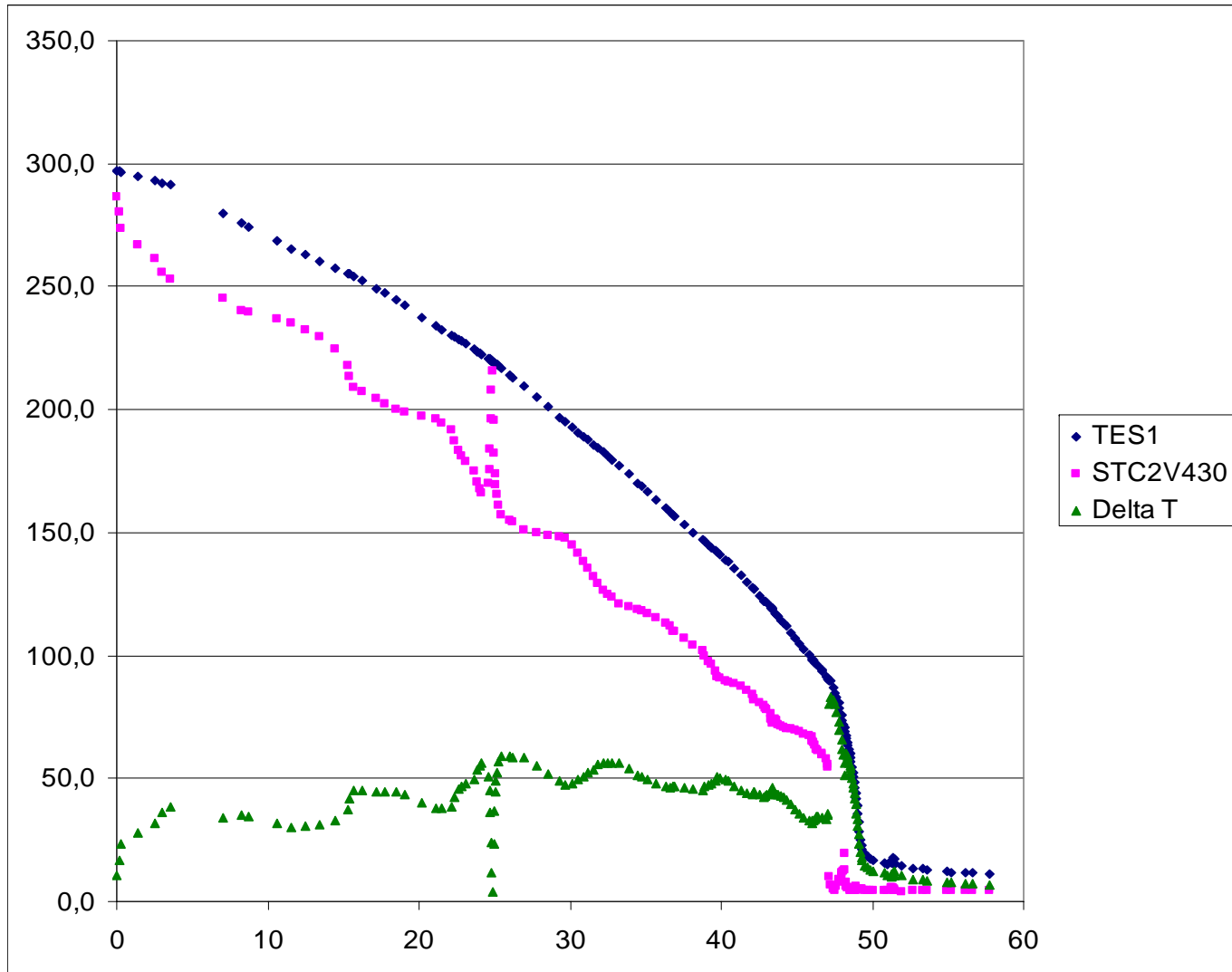
Measured data at CMTB – outer shield



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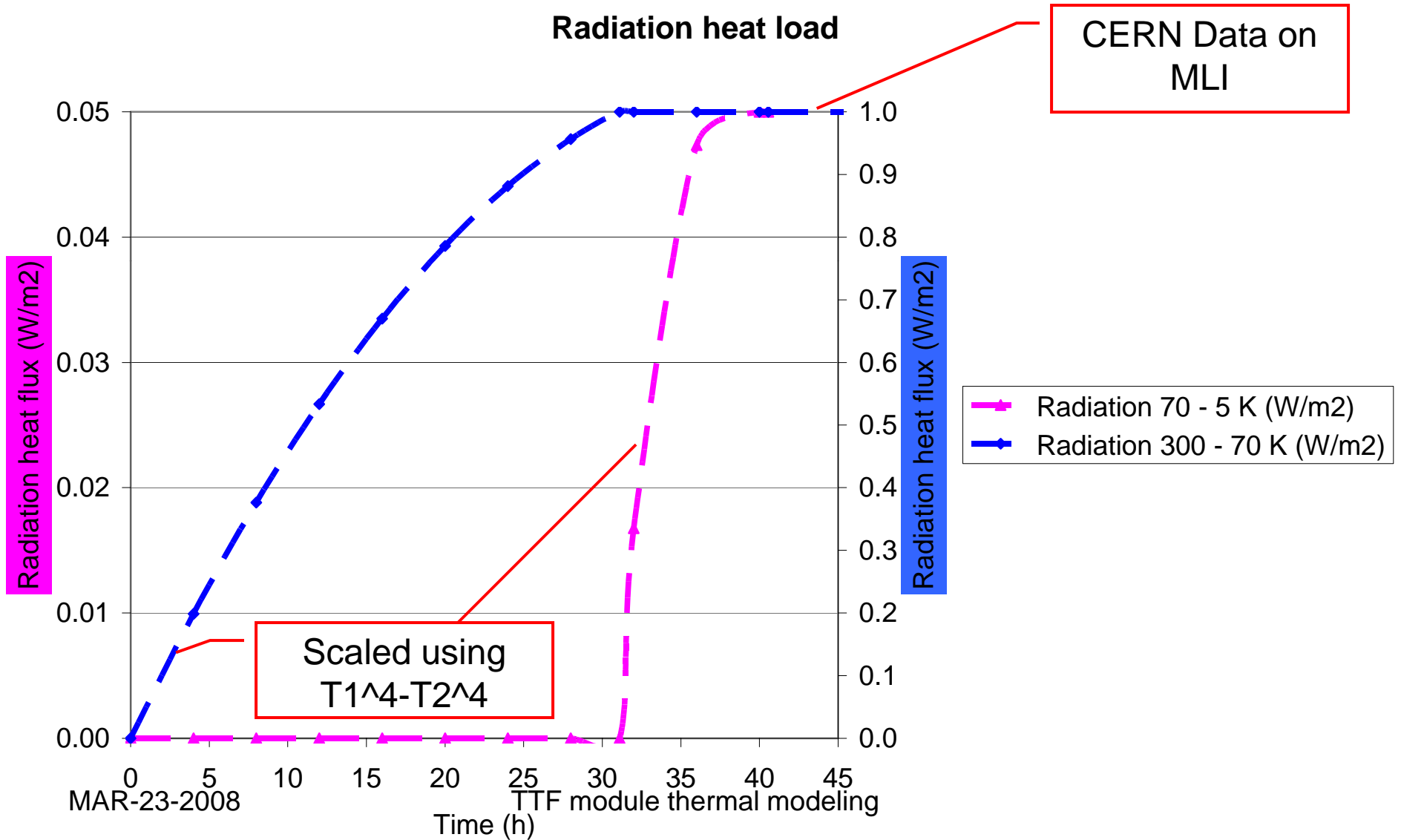
Measured data at CMTB – inner shield



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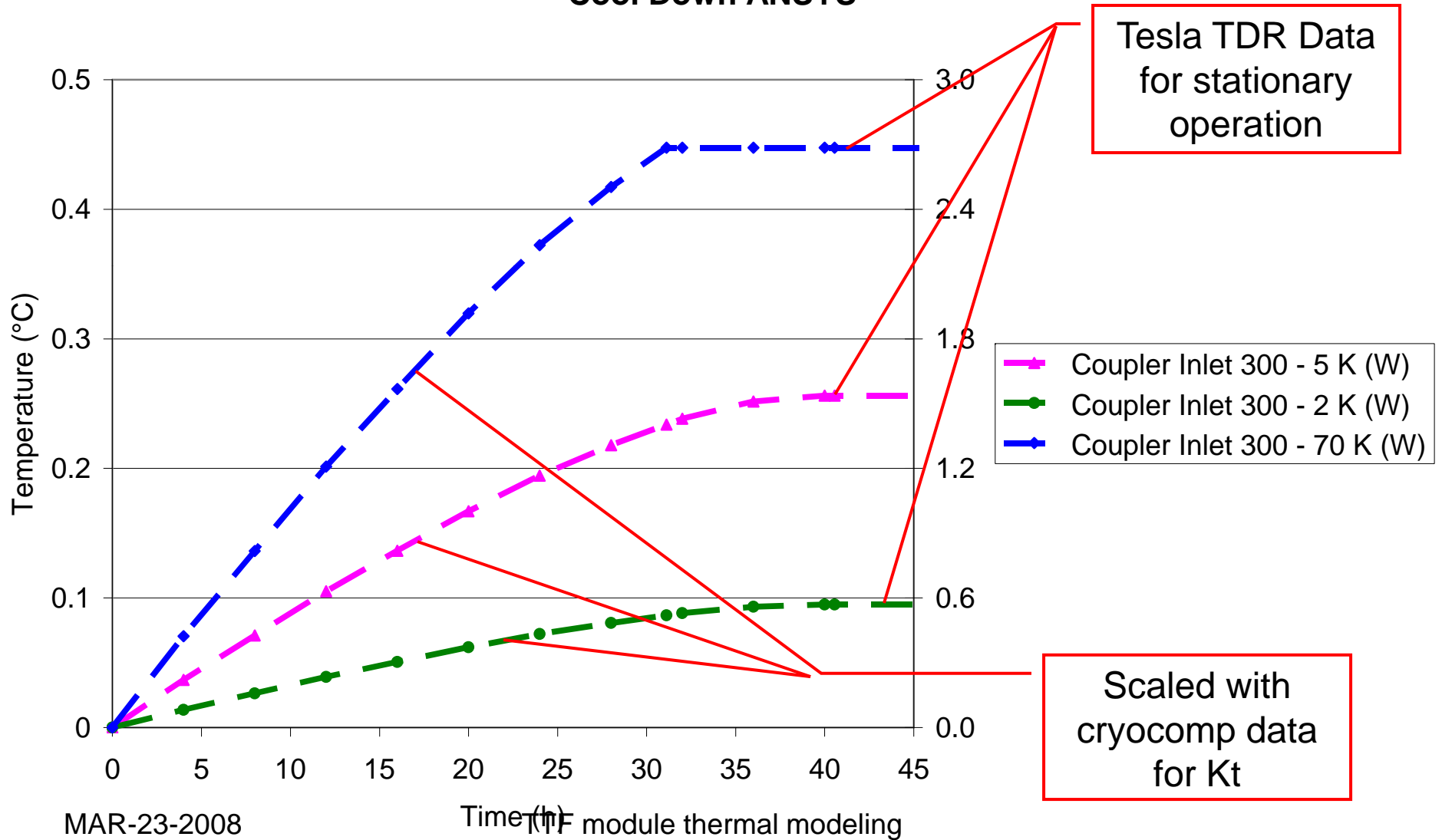
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Shield radiation



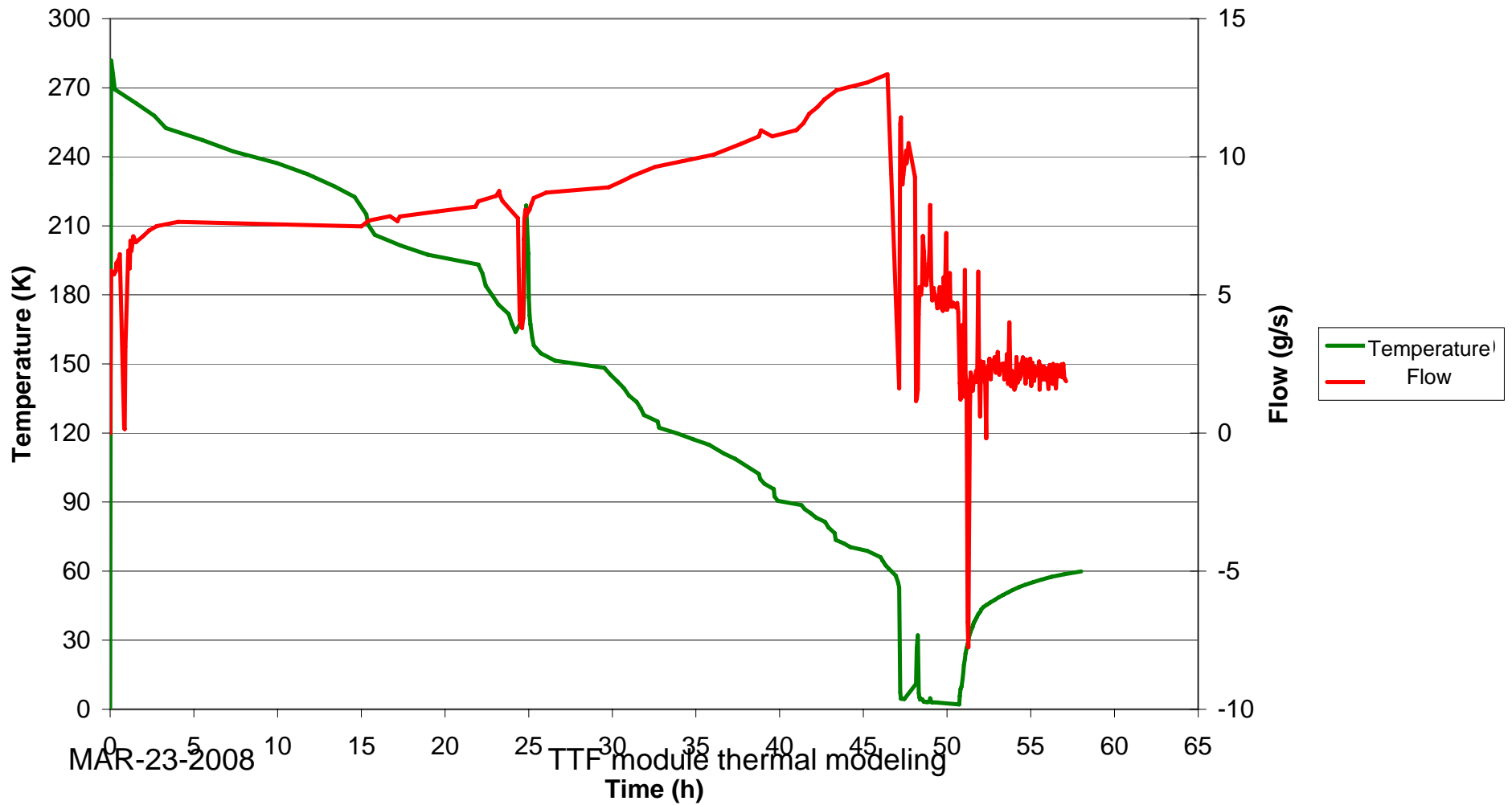
Conduction at couplers

Cool Down ANSYS



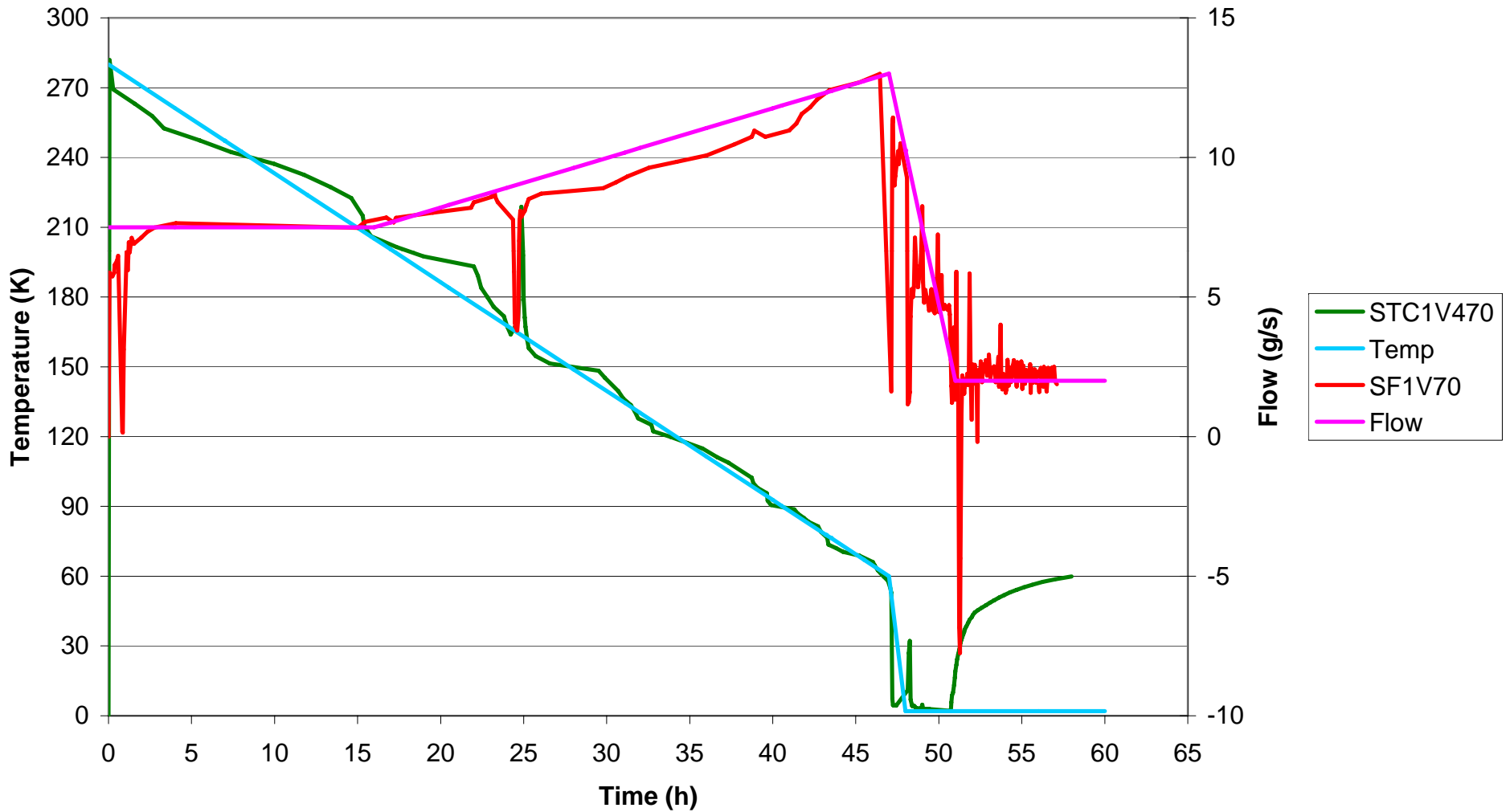
Real data at DESY - CMTB

2K circuit data at CMTB (module 3*)



Fluid parameters, 2 K circuit

2K circuit data at CMTB (module 3*)

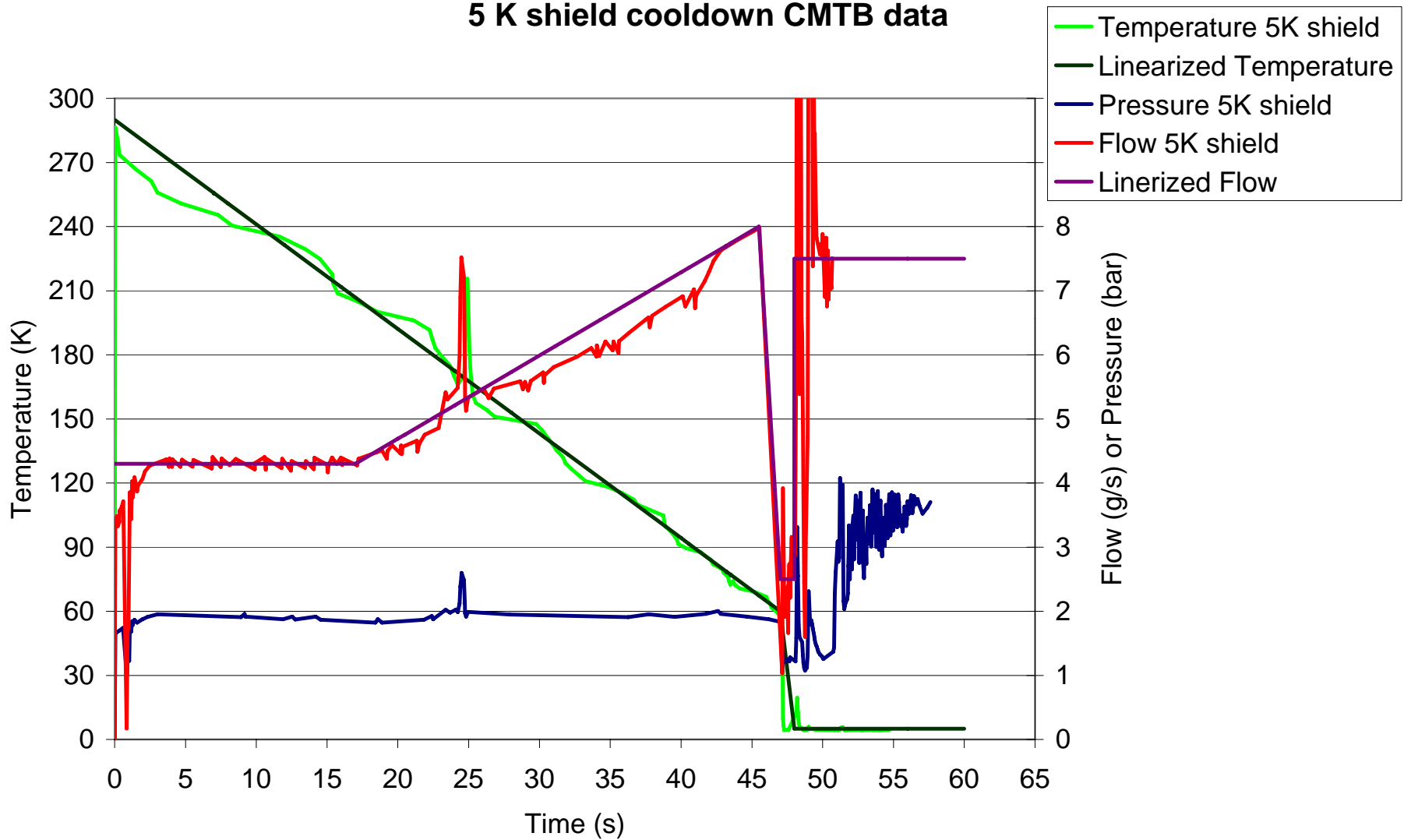


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Fluid parameters, 5 K circuit

5 K shield cooldown CMTB data

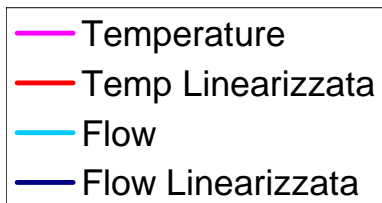
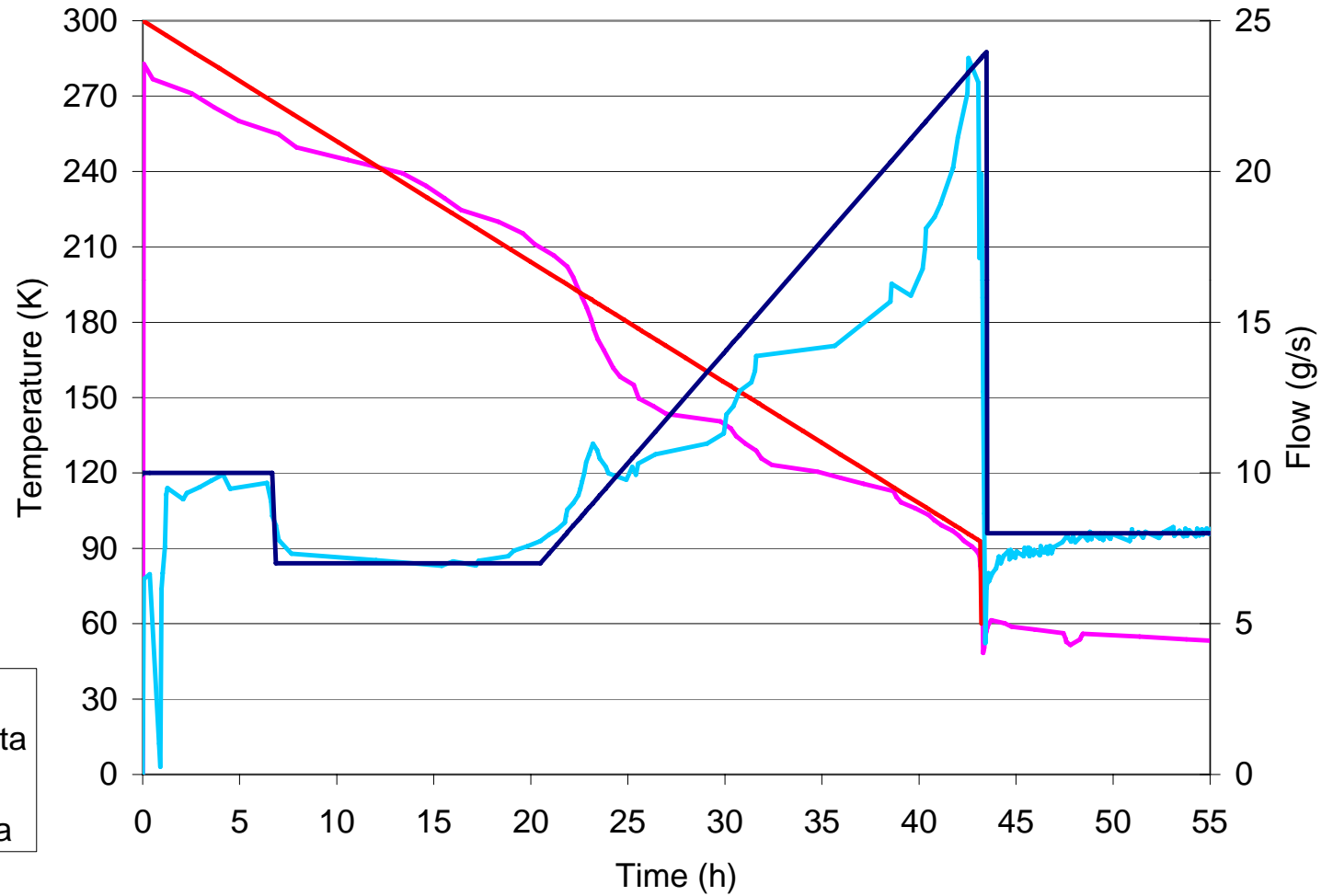


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Fluid parameters, 70 K circuits

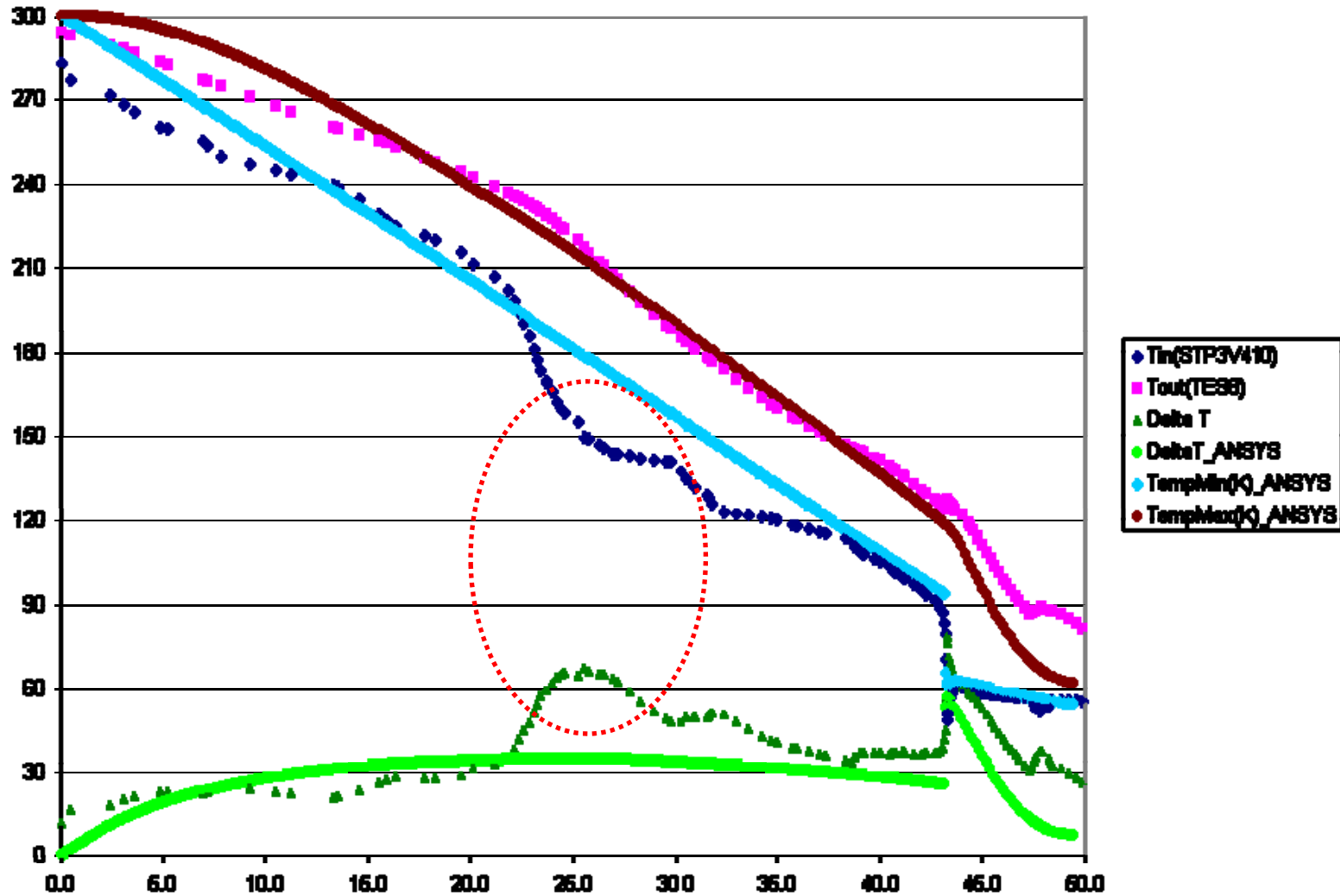
50 K shield cooldown CMTB data



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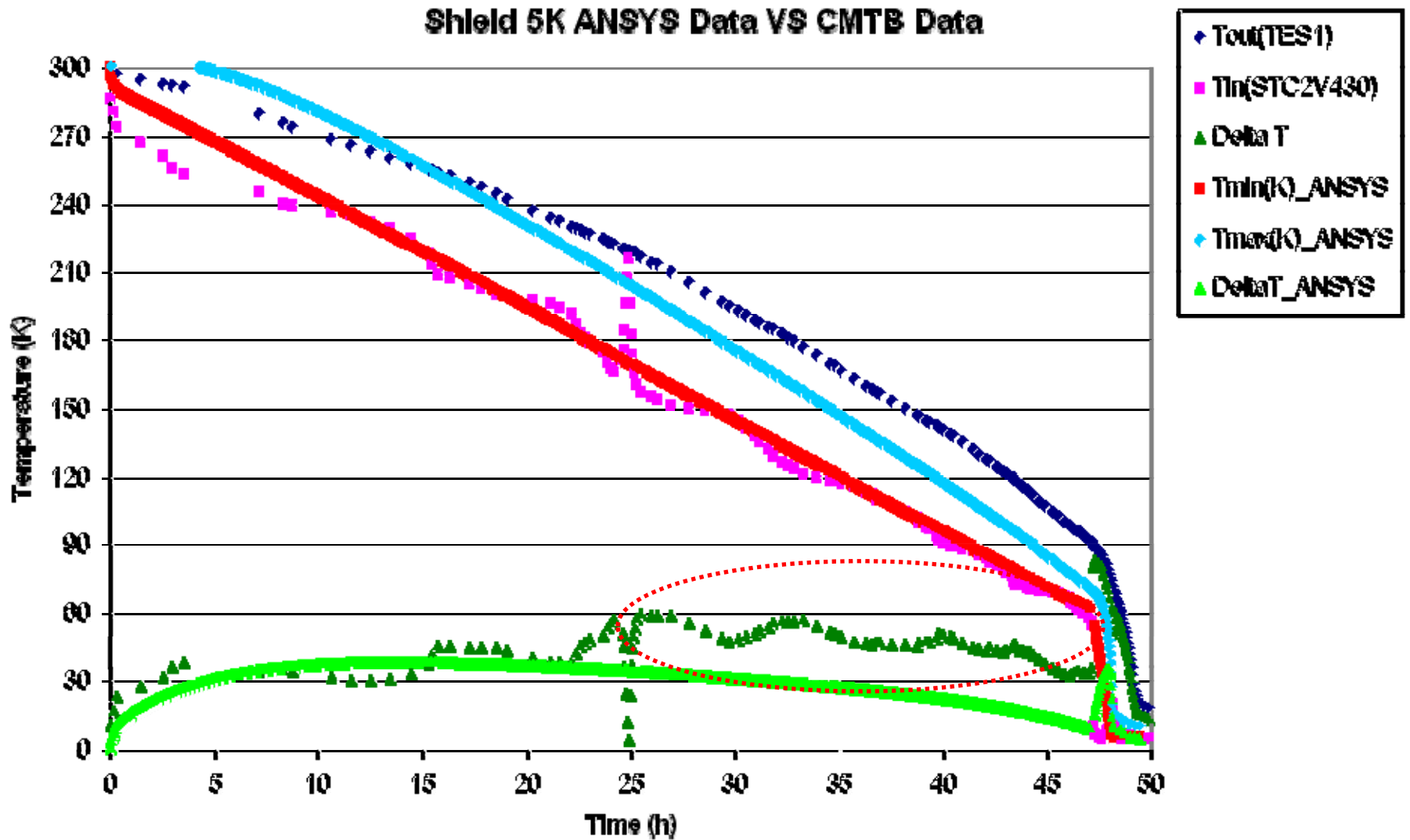
Results with CMTB cooldown – 70 K



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Results with CMTB cooldown – 5 K



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000_cry3_GRP+shields_CMTB [Project] | 000_cry3_GRP+shields_CMTB [Simulation]

File Edit View Units Tools Help | New Analysis Solve

Result: 1.0 (True Scale) | Probe

Outline for "000_cry3_GRP+shields_CMTB"

- Heat Flow Coupler6_5K
- Heat Flow Coupler7_5K
- Heat Flow Coupler8_5K
- Heat Flow GRP_2K
- Convection GRP 2K
- Solution**
 - Solution Information
 - Temperature - All Bodies - End Time
 - Temperature schermo 70K
 - Temperature schermo 4K
 - Temperature GRP+shapes
 - Temperature - All Bodies - 144000s
 - Temperature - All Bodies - 60000s - maxGradie
 - Temperature - All Bodies - 100s
 - Temperature - All Bodies - 3600s - 1h
 - Temperature - All Bodies - 7200s - 2h
 - Temperature - All Bodies - 14400s - 4h
 - Temperature - All Bodies - 28800s - 8h
 - Temperature - All Bodies - 36000s - 10h
 - Temperature - All Bodies - 50400s - 14h
 - Temperature - All Bodies - 72000s - 20h
 - Temperature - All Bodies - 115200s - 32h
 - Temperature - All Bodies - 144000s - 40h
 - Temperature - All Bodies - 172800s - 48h
 - Temperature - All Bodies - 183600s - 51h
 - Reaction 70K
 - Reaction 300K
 - Reaction shapes 2K
 - Reaction 4K
 - Heat Flux Probe
 - Temperature Shield70K-In_pipeSide
 - Temperature Shield70K-In_otherSide
 - Reaction GRP 2K

Temperature schermo 70K

Type: Temperature
Unit: °C
Time: 183000
23/4/2008 1:59 PM

-213.41 Max
-219.83 Min

0.000 0.500 1.000 1.500 2.000 (m)

Details of "Temperature schermo 70K"

Scope
Geometry: 12 Bodies

Definition
Type: Temperature
Display Time: 1.83e+005 s

Results
 Minimum: -219.83 °C
 Maximum: -213.41 °C
 Minimum Occurs On: Tube_Tube70K
 Maximum Occurs On: TegoloOut_70K

Information

Geometry | Worksheet | Print Preview | Report Preview

Timeline: Animation | 10 Frames | 2 Sec (Auto)

27.001
-40.
-120.
-220.17
0. 40000 80000 1.2e+5 1.6e+5 2.16e+5

1.83e+5

2

Messages | Timeline

Tabular Data

Time [s]	Minimum [°C]	Maximum [°C]
1	27.	27.
2	27.	27.
3	27.	27.
4	27.	27.
5	26.999	27.
6	26.989	27.
7	26.937	27.
8	26.81	27.
9	26.663	27.
10	26.549	27.
11	26.431	27.
12	26.252	27.
13	26.063	27.001
14	25.86	27.001

Press F1 for Help | No Messages | No Selection | Metric (m, kg, N, °C, s, V, A)

Loads



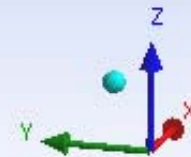
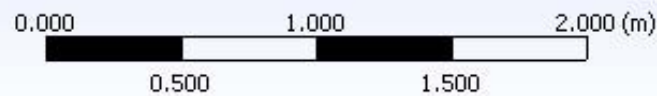
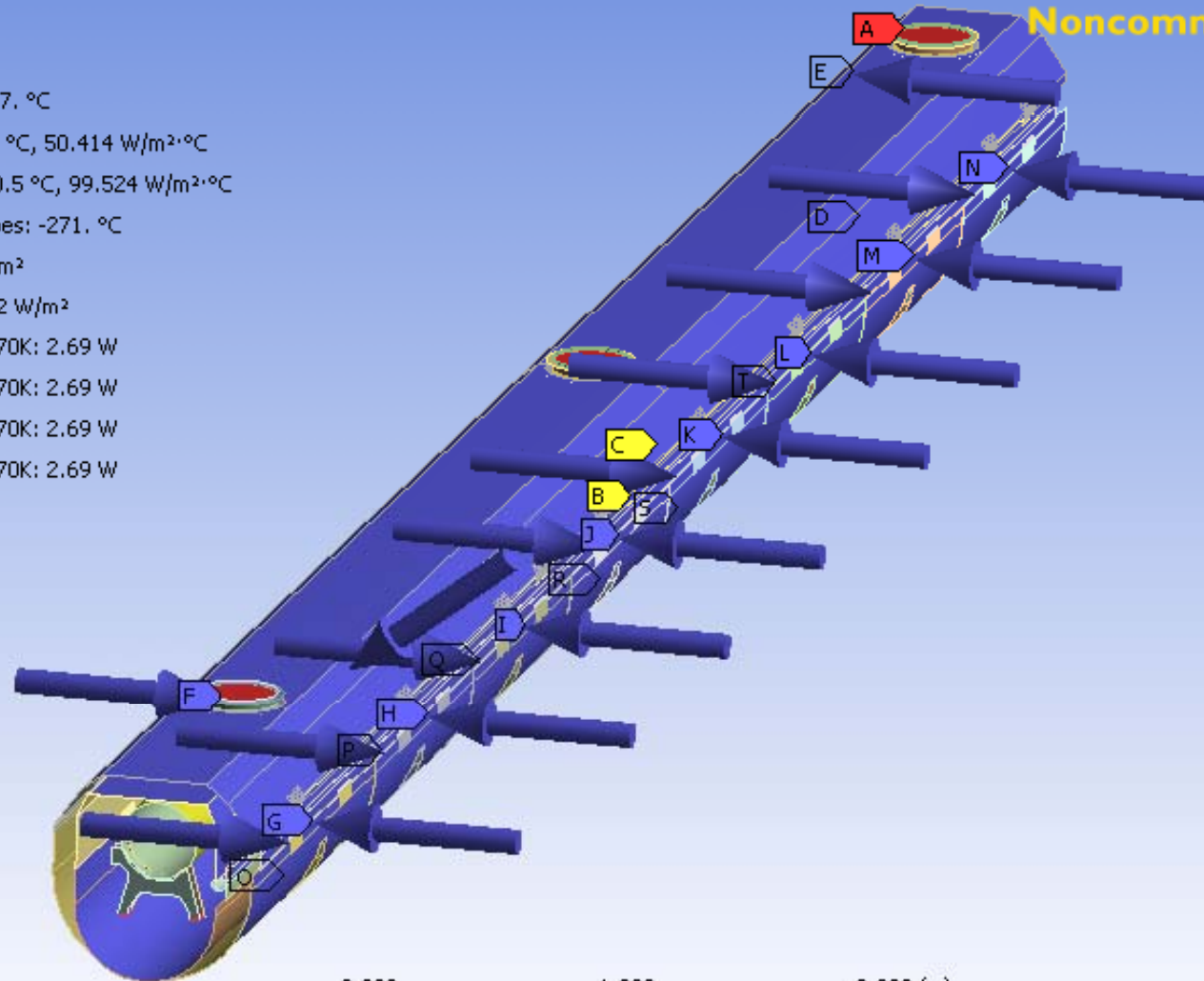
Transient Thermal - tutto 60h

Time: 2.16e+005 s

Items: 10 of 24 indicated

23/4/2008 2:08 PM

- A** Temperature 300K: 27. °C
- B** Convection 4K: -268. °C, 50.414 W/m²·°C
- C** Convection 70K: -220.5 °C, 99.524 W/m²·°C
- D** Temperature 2K shapes: -271. °C
- E** Heat Flux 70K: 1. W/m²
- F** Heat Flux 4K: 5.e-002 W/m²
- G** Heat Flow Coupler1_70K: 2.69 W
- H** Heat Flow Coupler2_70K: 2.69 W
- I** Heat Flow Coupler3_70K: 2.69 W
- J** Heat Flow Coupler4_70K: 2.69 W



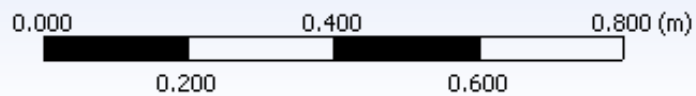
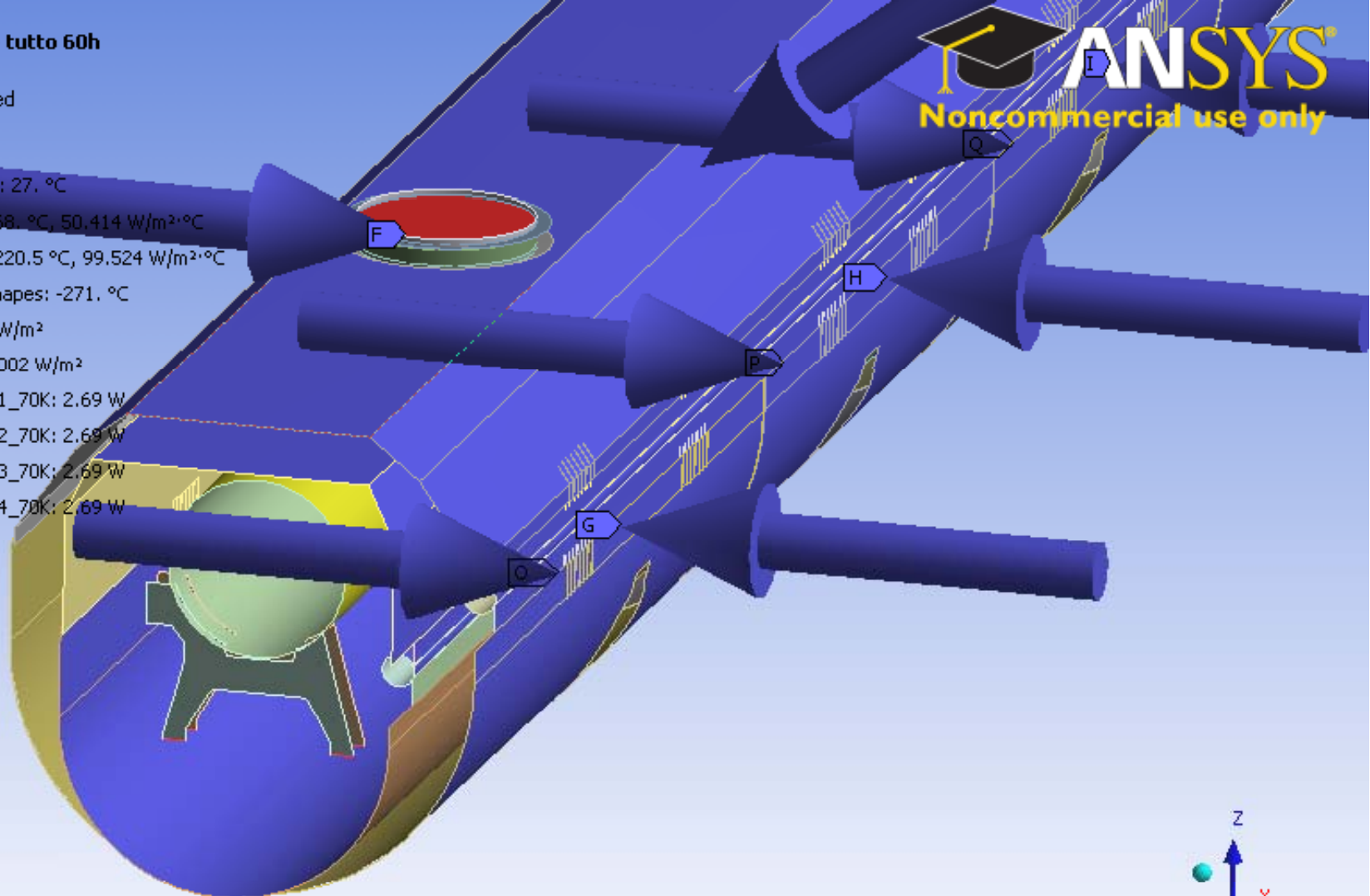
Transient Thermal - tutto 60h

Time: 2.16e+005 s

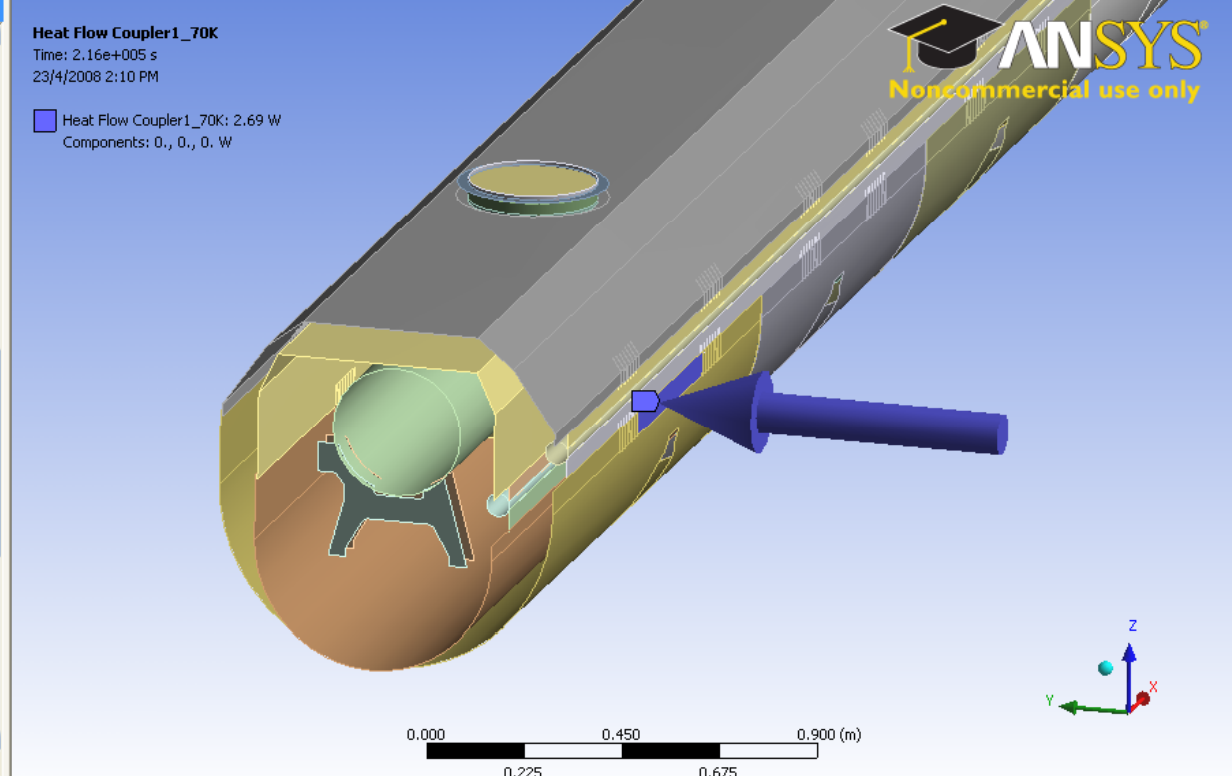
Items: 10 of 24 indicated

23/4/2008 2:08 PM

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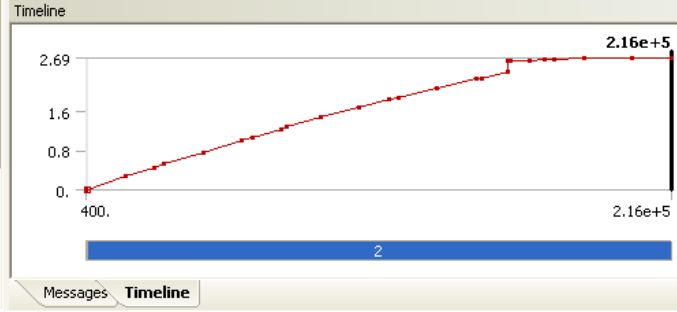
- Reaction 300K
- Reaction 70K
- Reaction 5K
- Reaction 2K
- Transient Thermal - tutto 60h**
 - Initial Condition
 - Analysis Settings
 - Temperature 300K
 - Convection 4K
 - Convection 70K
 - Temperature 2K shapes
 - Heat Flux 70K
 - Heat Flux 4K
 - Heat Flow Coupler1_70K**
 - Heat Flow Coupler2_70K
 - Heat Flow Coupler3_70K
 - Heat Flow Coupler4_70K
 - Heat Flow Coupler5_70K
 - Heat Flow Coupler6_70K
 - Heat Flow Coupler7_70K
 - Heat Flow Coupler8_70K
 - Heat Flow Coupler1_5K
 - Heat Flow Coupler2_5K
 - Heat Flow Coupler3_5K
 - Heat Flow Coupler4_5K
 - Heat Flow Coupler5_5K
 - Heat Flow Coupler6_5K
 - Heat Flow Coupler7_5K
 - Heat Flow Coupler8_5K
 - Heat Flow GRP_2K
 - Convection GRP 2K
- Solution
- Solution Information



Details of "Heat Flow Coupler1_70K"

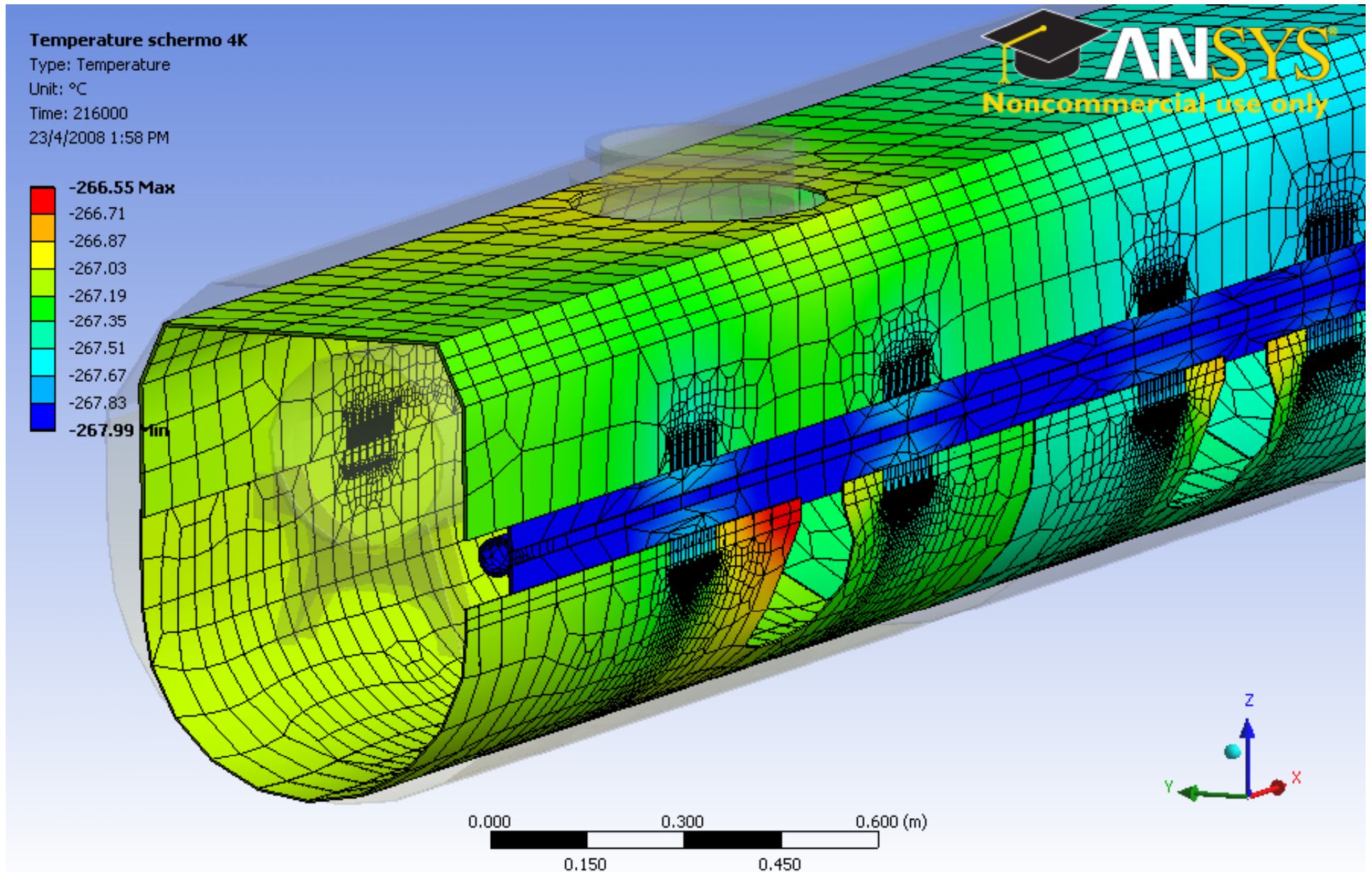
Scope	
Scoping Method	Geometry Selection
Geometry	1 Face
Definition	
Type	Heat Flow
Define As	Heat Flow
Magnitude	Heat Flow vs. Time 70K
Suppressed	No

Geometry Worksheet Print Preview Report Preview

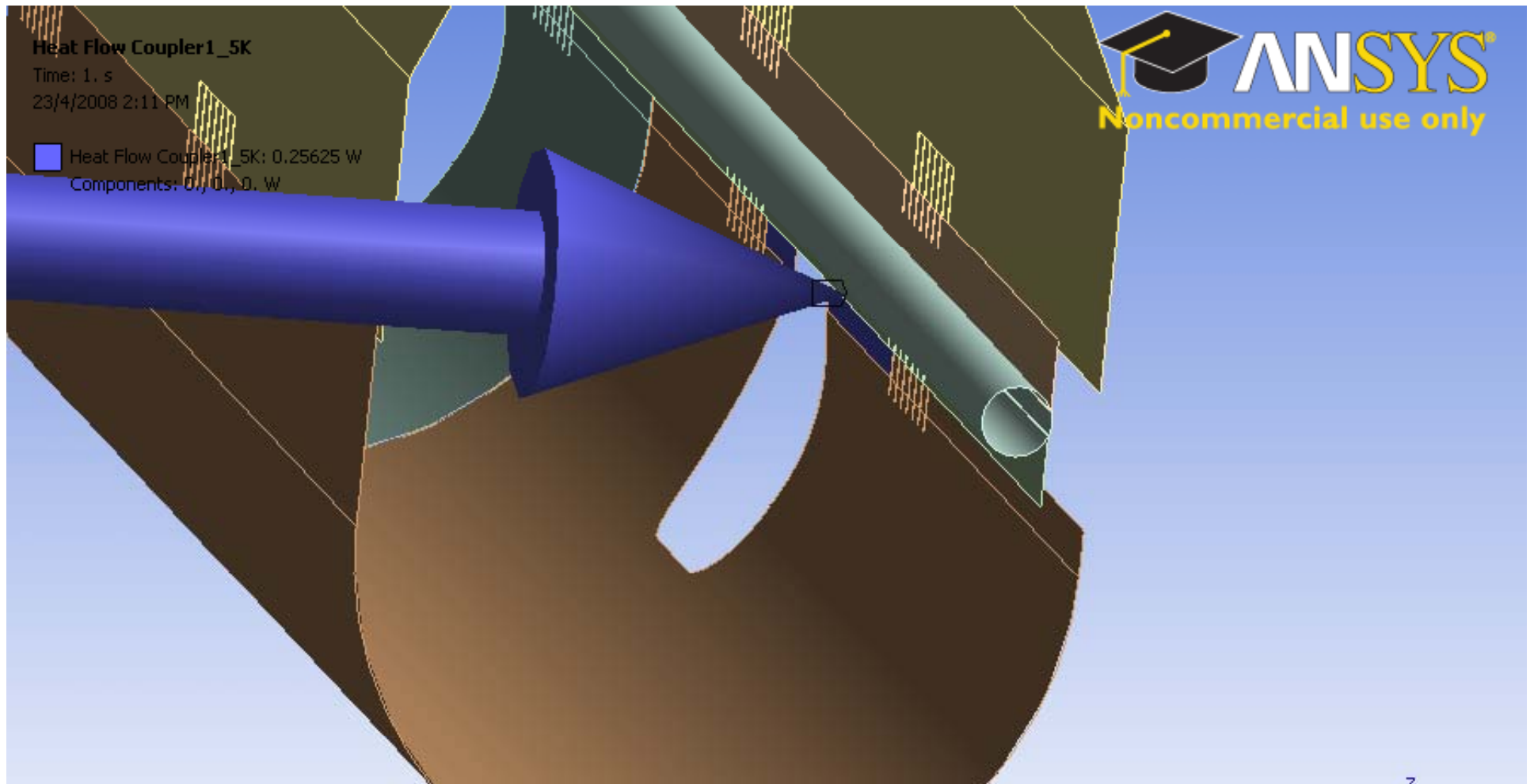


Tabular Data			
Steps	Time [s]	Heat Flow [W]	
1	1	0.	
2	1	400.	= 7.5e-003
3	2	14400	0.27
4	2	25200	0.46
5	2	25201	0.46
6	2	28800	0.52
7	2	43200	0.77
8	2	57600	1.
9	2	61200	1.07
10	2	72000	1.24
11	2	73800	1.28
12	2	86400	1.48
13	2	1.008e+005	1.68

Detail of inner shield



Position of coupler load on model



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